1. Assembly may be broken to the desired number of positions.

2. True position tolerance of the post tips is held flat against the printed circuit board.

3. The noted dimensions apply at the intersection of the post and housing.

4. Point of measurement for plating thickness.

5. 0.00625 [0.00025] gold in contact area.

6. 0.00254 [0.00010] - 0.00508 [0.00020] matte tin-lead on solder tail all over.

7. Preliminary part - not released for production.

8. High temperature configuration.
